XMM OPTICAL MONITOR

MULLARD SPACE SCIENCE LABORATORYUNIVERSITY COLLEGEH.E.Huckle, N.R.Bray, R.Card, R.Chaudery, T.E.Kennedy, D.Self,
P.Sheather, P.J.Smith, J. Tandy, P.Thomas, M.C.R.Whillock

XMM-OM USER MANUAL

EXPERIMENT ON-BOARD SOFTWARE -

INSTRUMENT CONTROL UNIT

Document: XMM-OM/MSSL/ML/0008.5

XMM-OM Project Office	A Dibbens	Orig.
ESA PX	H Eggel	\checkmark
CSL	P RochusS Roose	
Los Alamos National Laboratory	С Но	\checkmark
UCSB	T. Sasseen	\checkmark
Royal Greenwich Observatory	R Bingham	
Mullard Space Science Laboratory University College London	 R Card M Carter R Chaudery J Fordham H Huckle R Hunt H Kawakami T Kennedy D Self P Smith P Thomas M Whillock K Mason A Smith 	
Author:	Date: 17/0)6/99 2:09 PM
OM Project Office	Date:	
Distributed:	Date:	

Distribution:

This copy printed at 11:33 AM on 12-May-00

1

CHANGE RECORD

Issue	Date	Comments
Draft	1 Sep'97	Draft Version for Comment
1	22-Sep-'97	Issued after comments
1onc		Input comments from States
8.draft	23 Jun '98	Re-issued as FM User Manual
8.1	3-July-'98	Issued for FM Delivery.
8.2	30-Oct-98	Re-structured for consistency with DDD.
8.3	27-Apr-99	Corrected Page Header.
	r	Removed 'no bar' comment from f/w position table.
		Clarified Full and Intermediate modes on mode diagram and table.
		Fixed various typographical errors.
		Added Mode numbers to mode table.
		Added sections on Memory Mapping.
		Added section on watchdog operations.
		Enhanced summary of ICU.
		Ensured references to other parts of user manual correct.
		Corrected/clarified 'purpose and scope' description.
		Added MFN to test command in command summary section.
		Corrected heater description to allow for non-connection of Ref A (NCR 88).
		Added additional explanation for the mechanisms, including loss of HK.
		Additional Information on time supplied to DPU.
		Added summary of time synchronisation and verification.
		Corrected command summary to be consistent with new release of tc-tm document.
		Corrected ICB extension value.
		Added references to additional documents.
		Corrected overview memory addresses to FM values.
		Removed references to EGSE in MACSbus description as they were not used.
8.4	31-Aug-99	Corrected f/w position in mode table for safe mode.
		Clarified operation of coarse and fine sensors on filter wheel.
		Added sections on the TMPSU, DEMPSU and Image Intensifier.
		Renumbered sections to reflect DEM / Telescope Module Subdivision.
		Added section on flood LED's.
		Added note to the RBI section about NCR 177.
8.5	12 May 00	NCR192 – Additional section added describing the release 10 onwards
		modifications that enable automatic focus heater control – see section 2.2.4.6.
		ECR088 – Description of modes stating additional safing constraints regarding
		filter wheel position.
		ECR088 – Description of Modes states that the f/w must be in blocked position
		for any HV ramp-up.
		ECR 086 – It is now possible to command a transition to one of Full Safe,
		Intermediate Safe, Idle, Science or Engineering even if that is already the current
		mode.

TABLE OF CONTENTS

1. INTRODUCTION	1
1.1 Purpose and Scope	1
1.2 Applicable Documents	1
1.3 Terms and Abbreviations	2
2. OVERVIEW	5
2.1 XMM Mission	5
2.2 OM Experiment	5
2.2.1 Science	5
2.2.2 Architecture Overview	6
2.2.3 Digital Electronics Module (DEM)	7
2.2.3.1 ICU	
2.2.3.2 DPU	
2.2.3.3 DEMPSU	
2.2.3.4 Interfaces	
2.2.3.4.1 Serial Synchronous Interface (SSI)	
2.2.3.4.2 Time to DPU	
2.2.3.4.3 Instrument Control Bus (ICB)	
2.2.3.4.4 RBI 2.2.3.4.5 DBU	
2.2.4 Telescope Module	
2.2.4.1 TMPSU	
2.2.4.2 Detector System	
2.2.4.2.1 Camera Head	
2.2.4.2.2 High Voltage Control Unit	
2.2.4.2.3 Image Intensifier	
2.2.4.2.4 Detector Processing Electronics	
2.2.4.3 Mechanisms	
2.2.4.3.1 Filter Wheel	
2.2.4.3.2 Dichroic Mechanism	
2.2.4.4 Flood LED's	
2.2.4.5 Heaters and Thermistors	
2.2.4.6 Automatic Focus Heater Settings	
2.3 Software	
2.3.1 Modes	
2.3.1.1 Off	
2.3.1.2 Bootstrap Init	
2.3.1.3 Bootstrap Reset	
2.3.1.4 Initial/Basic	
2.3.1.5 Operational	
1	

This copy printed at 11:33 AM on 12-May-00

2.3.1.5.1	Safe	34
2.3.1.5.2	Idle	
2.3.1.5.3	Science	
2.3.1.5.4	Engineering and Calibration	
2.011.011	Wait State	
	erview	
	otstrap Code	
	sic and Operational Code	
2.3.2.3.1	Summary of Telecommands.	
2.3.2.3.2	Start Task Management Commands.	38
2.3.2.3.3	Stop Task Management Commands.	
2.3.2.3.4	Load Task Management Commands	
2.3.2.3.5	Report Task Commands.	41
2.3.2.3.6	Mode Change Commands	
2.3.2.3.7	Memory Management.	42
2.3.2.3.8	Telemetry Maintenance	45
2.3.2.3.9	Time Management.	45
2.3.2.3.10	Test Commands	45
2.3.2.3.11	Summary of Telemetry	46
2.3.2.3.12	Main Software Components for Basic and Operational.	47
2.3.2.3.13	Overview of Principle Memory Areas	49
2.3.3 DPU.		52
	erview	
2.3.3.2 Glo	bal RAM Map	52

1. Introduction

1.1 Purpose and Scope

This manual gives an overview of the XMM Optical Monitor (OM) hardware so as to give acontext to the OM software. It liten gives an overview of the ICU and DPU software, with emphasis on the ICU. Further details regarding the commands and telemetry can be found in APP-3 and APP-4 (see below). A detailed design description of the ICU software can be found in XMM-OM/MSSL/SP/O2O5(APP-8). The User Manual for the DPU can be found in APP-9. A detailed design description of the DPU software can be found in XMM-OM/UCSB/ML/OO13Where relevant, additional document references are given.

1.2 Applicable Documents

- APP-1 Packet Structure Definition
- APP-2 XMM Operations InterfaceRequirements
- APP-3 ICU-DPU Protocol Definitions
- APP-4 Telecommand & Telemetry Specification
- APP-5 User Requirements Specification
- APP-6 X MM-OM Bootstrap Specification
- APP-7 Instrument Controller Design Description
- APP-8 ICU Detailed Design Document
- APP-9 User Manual Digital Processing Unit
- APP-10 DPU Detailed Design Document
- APP-11 Software Setup of the Blue Detector Electronics

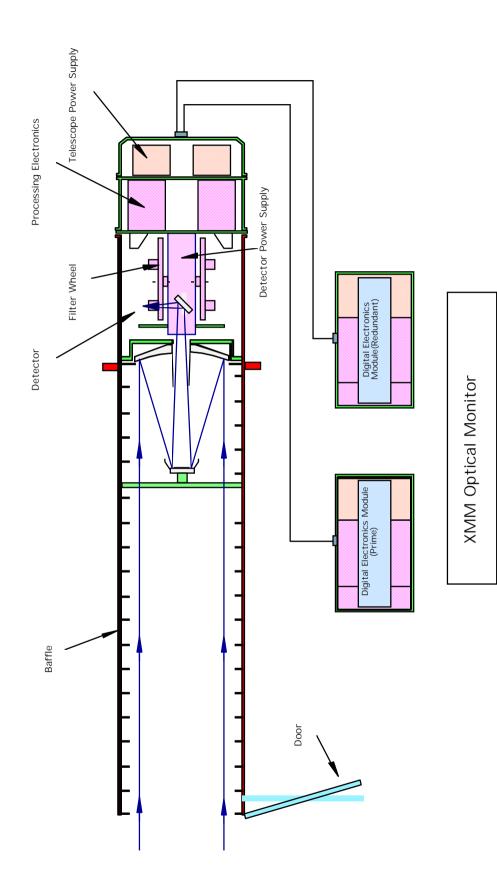
RS-PX-0032 RS-PX-0028 XMM-0M/MSSL/ML/0011 XMM-0M/MSSL/SP/0030 XMM-0M/MSSL/SP/0153 RGS-MSSL-1C-0002 XMM-0M/MSSL/SP/0205 XMM-0M/UCSB/ML/0012 XMM-0M/UCSB/ML/0013 XMM-0M/MSSL/SP/007/D2

1.3 Terms and Abbreviations

	Andrews to Dividal Communication
ADC	Analogue to Digital Conversion
APID	Application Identifier
BCH	Blue Camera Head (synonym for Detector Camera Head)
BPE	Blue Processing Electronics (synonym for Detector Processing Electronics)
CCA	Communications Area
CCD	Charge Coupled Device
CRC	Cyclic Redundancy Code
DEM	Digital Electronics Module.
DEMPSU	Digital Electronics Module Power Supply.
DBI	Digital Bus Interface
DBU	Digital Bus Unit.
DMA	Direct Memory Access
DMAE	DMA Enable
DPU	Digital Processing Unit
DSP	Digital Signal Processor
EM	Engineering Model
ESA	European Space Agency
FID	Function Identifier
FM	Flight Model
ICB	Instrument Control Bus
ICU	Instrument Control Unit
IO	Input Output
ISR	Interrupt Service Routine
KAL	Keep Alive Power
LSB	Least Significant Bit
MACSbus	Modular Attitude Control System bus
MFN	Master Function Number
MID	Memory Identifier
MSB	Most Significant Bit
MSSL	Mullard Space Science Lab
N/A	Not Applicable
OBDH	On Board Data Handling
OM	Optical Monitor
OM1	Synonym for the Telescope Module
OM2	Synonym for the Digital Electronics Module
OMIF	OM Interface card
PREF	Parameter Reference
PROM	Programmable Read Only Memory
PSD	Packet Structure Document
RAM	Random Access Memory
RBI	Remote Bus Interface
ROM	Read Only Memory
S/C	Spacecraft
SCET	Spacecraft Elapsed Time
SCI	Serial Communications Interface
SIBA	Spacecraft Interface Bus Adapter
SID	Structure Identifier
SSI	Serial Synchronous Interface
TBA	To Be Added
TBC	To Be Confirmed
TBD	To Be Defined/Determined
TBI	To Be Implemented
TC	Telecommand Packet
TID	Task Identifier
TM	Telemetry Packet
TM	Telescope Module
TMPSU	Telescope Module Power Supply Unit
TPN	Telemetry Packet Number
VBWL	Variable Block Word Length
XMM	X-ray Multi Mirror

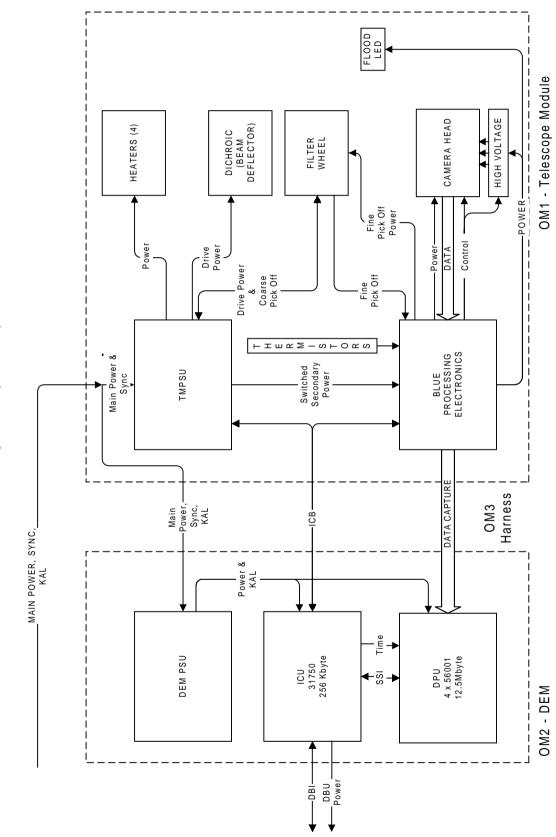
X MM-OM User Manual (FM)





This copy printed at 11:33AM on 12May-00

X MM+OM User Manual (FM)



This copy printed at 11:33AM on 12May-00

4

2. Overview

2.1 XMM N/ssion

The X-ray Multi-Mirror Mission (XMM) is an ESA spacecraft mission aimed at performing detailed imaging spectrophotometry of a wide variety of x-ray sources.

It is designed to be along duration (~10 years) observatory type mission, open to the astronomical community.

It is planned be launched at the end of the century (~1999), placed into a 48 horuhighly eccentric inclined orbit and have continuous ground station contact.

The payload is designed to be amutually complementary package composed of 3 instruments as follows:-

- EPIC European Photon I maging Camera
- RGS Reflection Grating Spectrometer
- OM Optical Monitor

2.2 OMExperiment

2.2.1 Science

The OM (Optical Monitor) experiment is designed to provide optical coverage of astronomical sources ismultaneously with the x-ray coverage provided by the EPIC and RGS instruments

On board optical observations remove the need for simultaneous ground lased observations which are difficult of organise, expensive and frequently fail due to bad observing conditions. There is also the added difficulty of correlating gourd event times with those from the space caft. Furthermore, a spaceborn optical monitor allows extension of the wavelength range into the UV.

Such simultaneous optical and x-ray information about astronomical x-ray sources is very important of understanding these objects and in particular provides :-

- Optical variability measurements simultaneously with x-ray measurements.
- A strometry. (e.g. Identification of optical counterparts)
- Broad band colours/ bw resolution spectroscopy.
- Improved space caft attitude reconstruction for the x-ray observations.
- Simultaneous correlation of optical & x-ray events/periods.
- Optical measurements extending into the UV. (The Hubble telescope is the only other way to provide this information but will be too leavily subscribed to perform this function for the XMM mission routinely.)
- Ratio of optical to x-ray flux. (Important for cosmological studies of quasars and galaxies).
- Studies of optical objects which may have no x-ray counterparts. (Serendipitous data which may be used for e.g. astro-seismology and micro-variability which may provide insight into the internal structure of such olipeds.)

2.2.2 Architecture Overview

The OM Instrument is composed of 3 units as follows:

TELESCOPE MODULE (TM)- OM1 - containing

- An optical/UV Ritchey-Chretian telescope
- A beam deflector and prime and redundant filter wheel, each with 10 filter positions and 1 blocked position.
- Heaters to control the temperature of the telescope tube and modify the focal length (if required).
- Prime and redundant detector processing electronics and camera head, including high voltage control and monitoring.
- Prime and redundant TM Power Supplies the TMPSU's see OM3 description for more information.

PRIME and REDUNDANT DIGITAL ELECTRONICS MODULES (DEM's) - OM2 - each containing a

- Digital Processing Unit (DPU). It performs basic science data reception and processing including image accumulation.
- Instrument Control Unit (ICU). The ICU provides the basic instrument control function, housekeeping monitoring and code up-link for both itself and the DPU. DPU processed data is passed to the Instrument Control Unit (ICU) processor for reformatting into packets prior to being passed to the spacecraft OBDH system.
- SSI Interface. The DPU and ICU communicate via a full duplex Serial Synchronous Interface (SSI).
- DBI. The interface from the ICU to the spacecraft for data downlink and command up-link will be carried by a digital bus interface (DBI). The ICU supports a telemetry rate of up to 8 kbps and a telecommand rate of 2 kbps.
- DEM Power Supply. This provides the conditioned power for the ICU and DPU in the DEM. It provides latchup protection.

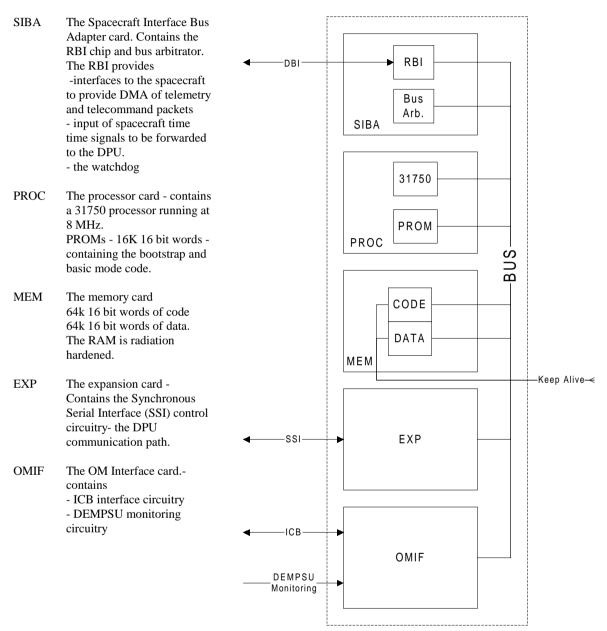
INTERCONNECTING HARNESS MODULE - OM3

• This harness carries power, synchronisation information, keep-alive line and an Instrument Control Bus (ICB) between the Telescope Module and the Digital Electronics Modules. The ICB is used by the ICU to control and monitor the detector, mechanisms and heaters via the TMPSU. It is based on the MACS-bus standard.

2.2.3 Digital Electronics Module (DEM)

2.2.3.1 ICU

This consists of 5 cards:-



Note - see section 2.2.5.4.2 about structure of, and access to, memory.

2.2.3.2 DPU

The DPU is a hybrid local/shared memory multiple processor computer. It shares the DEM with the ICU and DEMPSU.

Four Digital Signal Processor (DSP) cards access a global memory in series via a global bus, with access to the bus managed by an arbiter card. Each processor is granted access to the bus once per millisecond. Each DSP also has local memory. Each DSP is assigned specific tasks

White	Overall Management of the Other Processors via the Serial Command Interface (SCI)
	ICU communication
	Initial field acquisition
	Spacecraft drift tracking.
Blue 1 and 2	Data collection and initial processing (e.g. tracking frame image accumulation)
Red	Shift and Add Calculation (i.e. summation of image corrected for drift)

The global memory consists of 12.5 Mbytes of memory, divided into:-

Small Word Memory	4 Mwords of 16 bit words RAM. Used to store a tracking frame and full frame applications
Big Word Memory	1 Mwords of 24 bit words RAM. Stores accumulated images.
Program Memory	0.5 Mwords of 24 bit RAM and 8k 24 bit words of PROM.

Each DSP card has its own local memory (32k by 24 bit words) which can only be accessed by that DSP.

A block diagram illustrating the above is given overleaf.

2.2.3.3 DEMPSU

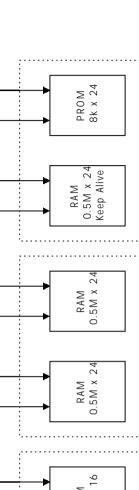
This power supply generates conditioned power for the DEM sub-systems. When the power is applied from the spacecraft, both the DPU and ICU are supplied, but subject to over-current protection on the output. Additionally the PSU receives as an input a signal from each of the DPU sub-system PCB's latchup protection circuits which cause the PSU to switch of the DPU main power when a latchup is detected. In this event, the ICU can command on the DPU power.

Secondary Rail	Destination
+6V	DBU
+5.3V-A	DPU main power
+5.3V-B	ICU main power
+3.3V-A	DPU KAL power
+3.3V-B	ICU KAL power

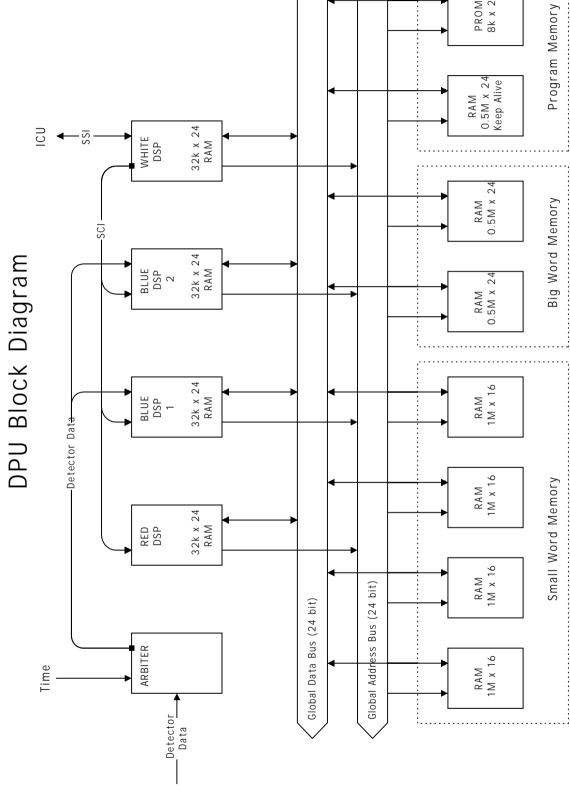
Key:

- DBU Data Bus Unit
- DPU Data Processing Unit
- ICU Instrument controller Unit

X MM-OM User Manual (FM)



This copy printed at 11:33AM on 12-May-00



σ

223.4 Interfaces

2.2.3.4.1 Serial Synchronous Interface (SSI)

Overview

The SSI is a bi-directional communications interface between the DPU and ICU which is carried on the DEM backplane.

The definition of the SSI is in X MM-OM/MSSL/SP/0007/Electrical Interfaces Specification".

Hardware

Both the ICU and the DPU can send and receive data on this interfacebut the ICU is the master.

The interface onsists of:

SSI_CLK	a continuous clock signal generated by the ICU
SSI_ENV_TX	active high when data presen
SSI_DATA_TX	16-bit data
SSI_ENV_RX	active high when data present
SSI_DATA_RX:	16-bit data
	Signal return

Commands are sent from the ICU to the DPU. Science data is passed from the DPU to the ICU when demanded by the ICU. A lerts are sent (unrequested) by the DPU to the ICU. There is no direct feedback as part of the protocol and there is no error correction no checksums. The interface can be thought of as the same irrespective of direction.

The SSI clock frequency is 125 kHz producing a period of 8 us (1 bit-period). The SSI 16-bit data words are separated by at least one bit-period and at most the SSI block gap (defined in software). The SSI data blocks are separated by at least the SSI block gap (defined in software).

Transmittingdata

The words that constitute the block are sent not more than the SSI block gap apart and, when finished, the software must wait for at least the SSI block gap before sending more data. The receiving software must wait for a little longer than the transmitting software's block gap to be sure to see the gap. A factor of two is sufficient

Recevingdata

The data being received must be read suitably fast and if the time between any two words is greater than the SSI block gap, the gap will be considered a block gap. All blocks contain a length as their second word so errors caused by an actidentally lengthened word gap may be identified (see data format).

SSI block gaps

Because the SSI block gaps are defined and used only in software they can be set to different values in different versions of the code and they can be different depending on the direction of the data (ICU->DPU or DPU->ICU).

SSI block gaps as defined by the ICU software

This copy printed at 11:33A M on 12-May-00

	EPROM code	Uploadable code
ICU -> DPU	>4 ms	>4 ms
DPU -> ICU	6ms	4 ms

SSI block gaps as defined by the DPU software

	EPROM code	Uploadable code
ICU -> DPU	2+/-1ms	2+/-1ms
DPU ->ICU	15+/-1ms	15+/-1ms

The ICU's SSI hardware will give an interrupt (used by the ICU's software) at the end of the first word of each block. The ICU software must laten read this first word before the end of the second word. The time for this is 16 bit-periods for the word and a minimum of 1 bit-period for the word gap. So the software must be able to respond to the interrupt and read the word in 136us.

An overflow (OVF) bit in the hardware SSI status word is made active (low) if a data word is not read before the arrival of another.

SSI errors

If the DPU resets whilst transmitting the first part of a word, that word will be truncated and the envelope will be truncated resulting in an earlier than expected "data receive" flag which will not be able to be processed in time and cause an overflow on the ICU.

If the DPU resets whilst transmitting the last part of a word, that word and the envelope will be truncated but not so much that the ICU's software cannot keep up as in the previous case. This will result in a corrupt ast word and, except in the case of a reset during the last word, a truncated SSI block. This will be detected and handled properly by the ICU's software.

Data format

The data format is described in XMM-OM ICU-DPU Protocol Definitions Each SSI data block consists of

- 1. 16-bit type the block type
- 2 16-bit length the number of 16-bit words following this word (i.e. total length 2)
- 3. the rest of the data

The data types are grouped into categories as follows

- 1. Regular DPU to ICU data blocks Regular science data.
- 2 DPU priority data
- These contain science data that is sent out as soon as it is available rather than at the end of an exposure. 3. DPU RAM dumps
- RAM dumps.
- 4. DPU to ICU alerts
- A lerts from the DPU to signify something is has happened, is ready or an error has occured.
- 5. ICU to DPU commands Commands to the DPU.

Further detail on the ICU software:-

This copy printed at 11:33A M on 12-May-00

X MM-OM User Manual (FM)

The first, fast part of the SSI interrupt handler is written in assembler (the first word of the SSI block is read) and the rest in written in A da (the reading of the rest of the words in the block and the timeout.)

SSI status register

D_TX	2**4
DATA_FULL	2**3
OVF	2**2
D_RX	2**1
INT	2**0

Sequence of actions

SSI INTERRUPT happens Read first word (from i /o addressf24 h) into input software fifo in less than 136 us after the interrupt Remember location where next word will be stored for a later check Start stopwatch Set interrupt mask to only allow RBI interrupts Enable interrupts but don't get interrupted for too long loop read SSI status (i/o addressf240) if the DATA_FULL bit (2**3) is set and there is data to output write adata word to output i/o address(724h) if input software fifo is full error if D_RX bit is reset read input word (i/o address f24 h) into input software fifo re-start stopwatch because there is still data on input else if stopwatch is after 4 ms break out of loop read ssi status word (i/o addressf240h) if OVF bit (2**2) is 0 clear overflow (write fffb (hex) to status register i/o address7240h) read a word (from i/o addressf241h) and dspose of it end loop read the second word (length) of this SSI block from the software input buffer if it is greater then 1027 error if no of words read doesn't equal the value of the second word (see bove) minus 2 error read ssi status word (i/o addressf240h) if OVF bit (2**2) is 0 clear overflow (write fffb (hex) to status register i/o address724) read a word (from i/o addressf241h) and dspose of it clear SSI interrupt by writing fffe (hex) to the SSI status i/o address 724 Oh

To Reset

reset software input and output fifos and error value write OV R_WR fffb (hex) to status address 724 @hex) write INT_WR fffe (hex) to status address 724 @hex)

SSI error codes

Error (Hex°	Comment
Ċ	The SSI input circular buffer has filled so fast or not been emptied fast enough and incoming data is about to overwrite outgoing data.
2	The word count is too large while receiving data in the block. The number of words has excended that indicated by the second "block length" word or has excended the maximum allowed (1029).
8	An overflow (OVF) has been indicated by the ICU's SSI hardware
7	An overflow occured at the end of the block.
11	The second word of the block indicated a length which exceeds the maximum allowed (102)?
1	The length indicated by the second word is inconsistent with the real length of the block
89	An overflow vas found during SSI_DRIVER.PUT
9	The length found in SSI_DRIVER.PUT exceeded the maximum allowed (1029).
b	The output block length in SSI_DRIVER.PUT exceeded the maximum allowed (1029).

2.2.3.4.2 Time to DPU

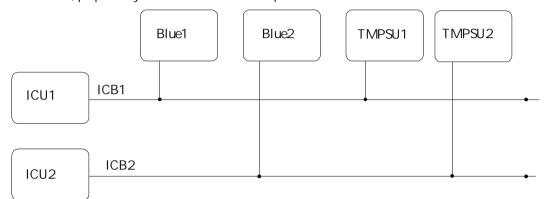
The time used by the DPU is synchronised to the space caft clock via a512*1024= 52428Hz dock supplied by the ICU. This clock is divided by 512in the DPU hardware and used to increment a 24 bit counter. Therefore the time counter is in units of 0.9766 ms (1024Hz) and rolls over every 4.55 hours. The most significant 14 bits contain the time in seconds. It is used in the time stamping of alerts from the DPU to the ICU.

Note: whenever an 'Add Time Code' command is sent to the ICU to adjust the on-board ICU time, the ICU forwards to the DPU (via the SSI) what the value of the least significant 14 bits of the seconds field will be at the next BCP2 pulse (i.e. next whole number of seconds). At that next BCP2 pulse the DPU resets its time counter appropriately (i.e. zeroes its least significant 10 bits and sets its 14 most significant bits to the value supplied).

2.2.3.4.3 Instrument Control Bus (ICB)

2.2.3.4.3.1 Scope

Control and monitoring of the instrument sub-systems are performed by the ICU. The ICB is the digital data highway that the ICU uses to send and receive commands and status. An existing standard has been adopted for the ICB called the MACS bus (Modular Attitude Control Systems bus) detailed in the "MACS Handbook", prepared by MATRA for ESA. It is a prioritised multi-master bus



2.2.3.4.3.2 Function

Because there are anumber of units on the bus the ICB has several functions. The detail of the functions performed on the bus is controlled by software in the ICU and EGSE.

The functions performed via the ICB are:

- 1. Loading of tables into the detectors.
- 2 Commanding of the detectors
- 3. Status monitoring of detectors
- 4. Reading filter wheel position sensors and temperature sensors.
- 5. Controlling power switching
- 6. Controlling heater switching
- 7. Controlling motor drives
- 8. Monitoring voltages/currents

The MACS bus specification defines a redundant bus. In the OM, redundancy is provided by two separate detector chains, and therefore only one MACS interface is used per redundant half.

The ICU always drives the dock on its bus

2.2.3.4.3.3 Interface

The ICB interface onsists of 4 signals

- ICB1_Clock
- ICB1_Data
- ICB2 Clock
- ICB2 Data

2.2.3.4.3.4 Protocol

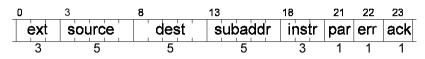
The lower layer of protocol is defined in the Section "MACS Protocol" of the MACS Handbook. This subsection defines the protocol that is required by virtue of the hardware design. Further layers of protocol may be defined as necessary in software.

ICB-commands are defined here as indivisible operations that may be performed on the MACS bus. Possible commands are:

- 16bit transfer of data from the ICU to the sub-system initiated by the ICU ICBsend
- 16bit transfer of data from the sub-system to the ICU initiated by the ICU ICBacquire

These ICB-commands are made up pairs¹ of ICB-words. ICB-words are 24 bits long and can be of one of two types ICBinstruction, or ICBdata:

ICBinstruction

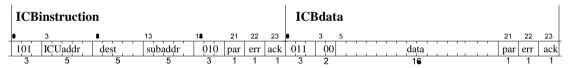


ICBdata

	0	3	5	21	22	23
	ext	XX	data	par		ack
-	3	2	16	1	1	1

The format of the ICB-commands are as follows:

ICBsend



Both ICB-words are generated by the ICU.

ICUaddr - the ICB address of the ICU. It will have the value of one of the source address defined below.

dest - the ICB address of the sub-system which should respond to this command

subaddr - if implemented defines one of 32 locations in the sub-system to which the data is to be assigned

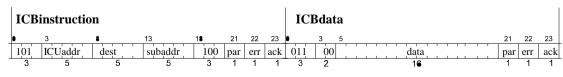
par - parity for the word

err - error condition, if true the command should be ignored

ack - acknowledge, generated by the sub-system

data - 16bit value to be used by the sub-system

ICBacquire



¹This is the simplest case. Other commands are possible with the MACS protocol, but are not used.

This copy printed at 11:33 AM on 12-May-00

The ICBinstruction word is generated by the ICU and the ICBdata word is generated by the sub-system that is addressed in the instruction.

ICUaddr -	the ICB address of the ICU. It will have the value of one of the source address defined below.			
dest -	the ICB address of the sub-system which should respond to this command			
subaddr -	if implemented defines one of 32 locations in the sub-system from which the data is to be acquired			
par -	parity for the word			
err -	error condition, if true during the instruction the command should be ignored, if true during ICBdata the response will be ignored by the ICU			
ack -	acknowledge, generated by the sub-system in response to the instruction, generated by the ICU in response to the ICBdata.			
data -	16bit value to be used by the sub-system			
The ICB addresses are:				
Source Addr	resses			

Destination Addresses 11000 - Blue Detector 00111 - TMPSU

ICU

2.2.3.4.3.5 Timings

00010 -

The timing of the interface is defined below:

Parameter	Min	Max	Units
Clock Frequency	500	512	kHz

2.2.3.4.4 RBI

2.2.3.4.4.1 Overview.

The standard RBI chip

- 1. provides the interface (via the DBI) between the ICU and the DBU (OBDH Data Bus Unit), only allowing interrogations if the address matches that of the ICU.
- 2. allows access to all the ICU memory, including the buffer areas for transfer of TC and TM packets (see below).
- 3. extracts BCP pulses (Broadcast Pulses) from OBDH interrogations which are used to generate interrupts for use by the software in the timer functions.
- 4. provides a 43 bit timer incremented by the OBDH clock signal at 524288 Hz.
- 5. provides a 12 bit programmable watchdog countdown timer, derived from the OBDH clock signal, at 256 Hz (see below).

The chip is fully described in "Standard RBI Chip for OBDH Interface", MC1031 Technical Information 2.8. All instructions described therein are supported. **NOTE** - NCR 177: during an ESTEC test, the 'suspend' instruction followed by a 'Go' instruction left the ICU in a non-running state. It has not been possible to reproduce this on the flight spare.

The protocol defining the 'handshake' for transfer of TC and TM packets, as well as timing information, is defined in "OBDH Bus Protocol Requirements Specification", XM-IF-DOR-0002.

2.2.3.4.4.2 Low Level Accesses Of The ICU's Memory By The Spacecraft.

(The text in this section is adapted from APP-7).

The RBI's Page address and Start address registers map the processors address lines and address state lines as follows, where AS0-3 are the address state lines, A0-15 the address lines and x are "don't care". (Note: the Base Address register will overlay the Page Address register for Immediate Read instructions and Reset Page Address Instructions.)

Page Address

RBI Proc		1 x		4 AS1	6 AS3	7 A0	9 A2	10 A3	11 A4	12 A5	13 A6	14 A7	15 A8
Start	Addr	ess											
RBI Proc	0 A1	1 A2	2 A3	4 A5	6 A7			10 A11	11 A12	12 A13	13 A14		15 note 1

Note 1: For flight this bit is "don't care", x.

As shown above the processor address lines are offset by one. This is because the RBI accesses memory one word at a time and increments it's address by two each time, so RBI bit 15 of the Start Address is not used.

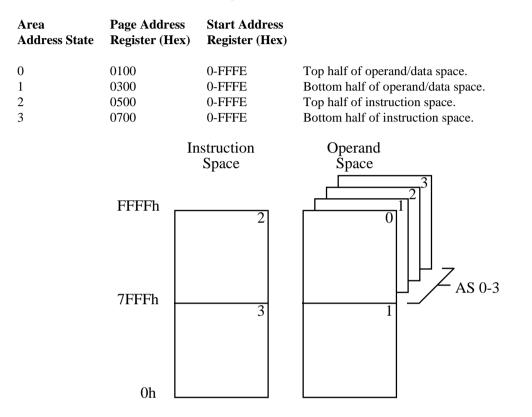
The processor has an address space of 64K words. To give enough area for the application code and working space for data, the processors OIN (operand instruction) control line is used to switch between two 64K words pages. Each page can be seen as two 32K word Areas, two in instruction space and two in operand space, as shown below in figure 2.

The RBI can directly see the whole of the Operand Space, areas 0 and 1, using the RBI register bits that correspond the processors A0 to A15 lines

This copy printed at 11:33 AM on 12-May-00

In addition Area "0" can be switched to any one of the four 32K Word Areas by manipulating the Address State lines indicated as AS0 to AS3 above.

For example An Address State of three (0011bin for AS0-3) would put Area "3" in the top half of the operand space. At the same time A0 would need to be set to a one and then A1 to A15 can be manipulated to address the 32K word block. Table 1 shows the set-up to access all four of the areas.



2.2.3.4.4.3 Watch Dog Operations.

(The text in this section is adapted from APP-7).

The OM will use the RBI's Watchdog timer, a twelve bit counter clocked by a 256Hz clock derived from the OBDH clock. This timer can give a programmable time out from 3.9mS to 16 seconds. If the timer reaches zero a PWDN (power down) interrupt is generated and 256uS later the IC will be reset. This timer is disabled on power up and is enabled by ICU software. If the ICU is suspended by the S/C this timer is stopped. When the ICU is allowed to continue the watchdog timer will resume from where it was stopped. The timer can be enabled and disabled by ICU software commands to the RBI's configuration register. The time out period is programmed by writing to the RBI's Watchdog Register, a value of FFF hex giving the longest time out period. The action of the write loads the value into the timer.

Note: The 31750 processor's watchdog function is not used.

2.2.3.4.4.4 *Time Synchronisation and Verification.* The following is a summary of section 7.2 of APP-7.

2.2.3.4.4.1 Synchronisation.

- 1. TC(10,1) is sent from the ground to the spacecraft telling the CDMU to synchronise time for the instrument.
- 2. The CDMU sends TC(10,2) to the ICU informing it that its local time is to be synchronised to the SCET.
- 3. The ICU enables time synchronisation to occur by commanding the RBI appropriately.
- 4. At least 100 ms later the CDMU generates a BCP3, BCP2 sequence, which resets the RBI time to zero. At the same time the DCMU takes a copy of the SCET. The RBI continues to count from zero.
- 5. Within a second the CDMU generates TC(10,3), "Add time code packet", containing a copy of the SCET.
- 6. The ICU takes a copy of the SCET. It discards the least 8 significant bits. The next 32 bits are written into the RBI. The RBI chip adds the value to the time value it has reached since the BCP3,BCP2 sequence. The remaining 8 bits of the SCET are kept in the ICU memory. **NOTE**: at this point the ICU will synchronise the DPU time to the ICU via the SSI interface see section 2.2.5.2.
- 7. The instrument time is now valid.

2.2.3.4.4.2 Verification.

- 1. The ground send a TC(10,4) to the CDMU.
- 2. The CDMU send a TC(10,5) to the ICU informing it that local time is to be verified.
- 3. The CDMU generates a BCP2 pulse after a delay of at least 100ms, at the same time taking a copy of the SCET. In the ICU the BCP4 pulse generates an interrupt.
- 4. The CDMU generates a TM(10,4) packet which contains a copy of the SCET at the BCP4 pulse.
- 5. The ICU, on reception of the BCP4 pulse, acquires the RBI time. Using this value and the value held in memory, the ICU builds the time field for a TM(10,5) and sends it to the CDMU.

2.2.3.4.5 DBU

See XMM-OM/MSSL/SP/0202 section 6.1 for a description of this interface.

2.2.4 Telescope Module

2.2.4.1 TMPSU

The telescope module power supply (TMPSU) converts the spacecraft 28V power bus to regulated switched and unswitched power rails within the telescope module. These are collectively referred to as the secondary power. The switched rails power the blue digital and analogue electronics and high voltages. The analogue electronics, in turn, controls the high voltages and powers filter wheel fine sensor LED and flood LED's. The unswitched rails power the mechanisms and filter wheel coarse sensor. The integral ICB interface provides the channel for control of the coarse sensor, flood LED's, analogue and digital electronics and also the return of current, high voltage and fine sensor status values. All switched rails are powered simultaneously on command via the ICB.

In addition. the +28V main s/c power, routed via the TMPSU, is used to drive the heaters.

The following table summarises what each secondary rail powers.

Rail	Switched?	BPE	BCH	HVU	FW	DM	TMPSU
+25V		-	Yes	Yes	-	-	-
+15V		Yes	-	Yes	-	-	-
+11V	Yes	-	Yes	-	-	-	-
+5.3V		Yes	Yes	Yes	-	-	-
-5.3V		-	Yes	-	-	-	-
-15V		Yes	-	Yes	-	-	-
+28V	No	-	-	-	Yes	Yes	-
+5V		-	-	_	-	-	Yes

Key:

BPE	Blue Processing Electronics
BCH	Blue Camera Head
HVU	High Voltage Unit
FW	Filter Wheel motor
DM	Dichroic Motor
TMPSU	TMPSU Internal

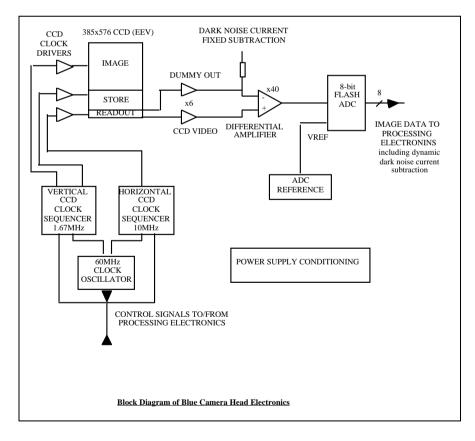
2.2.4.2.1 Camera Head

The sensor in the Camera Head (BCH) is an EEV CCD-02-06 which is a frame transfer device running with a vertical clock rate of 1.67 MHz and a horizontal readout rate of 10 MHz. The CCD is of well proven design and is used in many monochrome commercial and scientific TV applications. The dummy output from the CCD is subtracted from the video signal to reduce the level of saturation of the final video amplifier stage. The main cause of this is clock feed-through in the CCD wiring and the reset spike. The diagram below shows the functional blocks of the camera.

The CCD outputs are directly buffered with wide bandwidth emitter followers. The pre-amps are set at a gain of 4, and the differential amplifier at 10, giving a combined gain of 40. Because of the high read out rate, the video signal has settled to only approximately 75% of its final value at the instant of the ADC sample strobe. The gain is therefore slightly higher than that deduced from the CCD manufacturer's published data.

The horizontal clock sequencers and ADC sample strobe are derived from a highly stable ECL sequencer circuit based around a twisted ring counter. This, together with a fast horizontal driver circuit design, guarantees minimum timing jitter and hence low systematic noise as required for centroiding the image to 1/8th x 1/8th of a pixel.

Under control from the Blue Processing Electronics (BPE), the camera is capable of reading out of a number of windows in the CCD image in rapid succession, or full 256 x 256 pixel frames. The integration time is typically 12 ms.



2.2.4.2.2 High Voltage Control Unit

The High Voltage Control Unit (HVU) comprises three converters (see figure 1). Converter 1 and 2 work in parallel to produce the voltage across mcp1 bottom plate and cathode known as cathode voltage or $V_{cathode}$ and the voltage across mcp1 known as V_{mcp1} .

Converter 1 produces a negative voltage so that with the use of resistive division with converter 2 it obtains a zero volt output for $V_{cathode}$ on command. Potential reversal is possible but limited approximately to less than -15 volts by diode protection.

Converter 3 is in series with converter 1 and 2 and produces the bias voltage across mcp23 and the anode gap voltage known as V_{mcp23} and V_{anode} where V_{anode} is produced by extension of the voltage multiplier chain used to create V_{mcp23} .

In order to prevent potential reversal of any intensifier plate the bias voltages must be applied sequentially; this sequence being V_{anode}/V_{mcp23} -Vmcp1 then Vcathode. The HVU hardware will prevent any controlled static potentials from reverse bias conditions even if commanded to do so.

Due to the way the HVU works there are conditions in which rapidly control signals could cause momentary reverse bias conditions. i.e. a possibility of dynamic reverse bias. Because of this it is necessary that software commands for bias potentials be rise time limited.

It is recommended that any mcp rise time be limited to greater than 10 seconds from zero volts to maximum operating voltage and greater than 10 seconds from maximum operating voltage to zero volts.

Protection of over voltage on any mcp is also incorporated into the HVU hardware such that any command above maximum operating voltage will remain at maximum voltage as set within the HVU. It should be noted that this condition produces excessive noise on all outputs and so the HVU should not be operated in this condition. If this condition does arise it is necessary to command the voltage below maximum in order to regain control. The amount by which the commanded voltage has to drop depends on the particular mcp limiting and is shown in table 1.

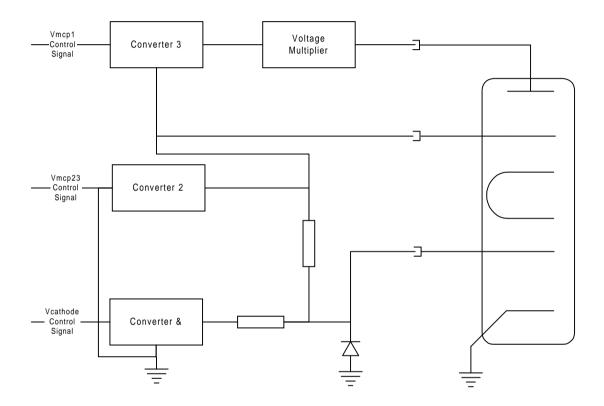
To operate the intensifier mcp23 is first raised to the desired operating voltage over a period defined by the rise time outlined above. V_{anode} will rise simultaneously with V_{mcp23} such that $V_{anode}=1.57*V_{mcp23}$. The voltage Vmcp1 will not be allowed to raise until V_{mcp23} is greater than 1100 volts (both intensifiers). Once V_{mcp23} is above this level V_{mcp1} can be raised to the desired operating voltage and is again rate of rise limited. For redundant intensifier the voltage across mcp1 must be greater than 518 volts before $V_{cathode}$ is allowed to rise and will cause $V_{cathode}$ to collapse if less than 505 volts. For the prime intensifier these restrictions are not incorporated into the hardware. Again the rate of voltage rise and decay for Vmcp1 should be limited above.

The cathode voltage $V_{cathode}$ is then raised to the desired operating level to effectively switch on the intensifier. To close down the intensifier the above procedure is reversed i.e. $V_{cathode}$ is set to zero volts then Vmcp1 and V_{mcp23}/V_{anode} . Both Vmcp1 and V_{mcp23}/V_{anode} decay rates are limited but $V_{cathode}$ can be commanded to zero instantly if required. Note that for the prime intensifier $V_{cathode}$ is limited to 530 volts and for the redundant intensifier $V_{cathode}$ is limited to 400 volts.

XMM-OM User Manual (FM)

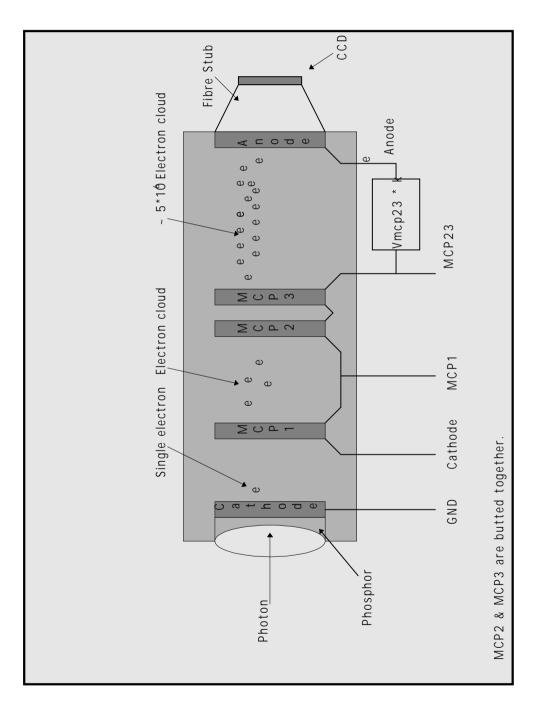
Intensifier protection limits.

Voltage	Limits at	Ideal Control
mcp23	2045 (< 1680V control reset)	< 2000V
mcp1	909V (< 780V control reset)	< 880V
V _{cathode} (Prime intensifier)	530V (< 518V control reset)	< 500V
V _{cathode} (Redundant intensifier)	2045V (< 380V control reset)	< 390V



This copy printed at 11:33 AM on 12-May-00

2.2.4.2.3 Image Intensifier



2.2.4.2.4 Detector Processing Electronics

224.24.1 General

The principal features of the detector processing electronics are:

Generation of the Detector Head clock sequences to operate the CCD in a frame transfer mode Specification of the area (windows) of CCD to be read out Event Detection. Event Centroiding Engineering Data. Construction and transmission of data to the DPU. ICB interfacefor control of the above.

N.B. The detector processing electronics is often referred to as the Blue Processing Electronics (BPE). This refers to an earlier design which included an additional detector more sensitive to the red end of the spectrum. The two detectors were labelled 'blue' and 'red'. A block diagram of the detector electronics is given overleaf.

The remainder of this section is abstracted from A PP-11.

224.24.2 Window Bitmap RAM

Before the detector processing electronics may be used, the window bitmap RAM must be loaded. The RAM is 64k by 4 lists. The information loaded will cause only those CCD pixels within the desired windows to be readout i.e. a docking sequence is generated for the desired camera format.

For every location on the CCD, there is a location in RAM. During a row readout, the corresponding RAM contents are interpreted as a window ID. An ID in the range 1 to 15 is a valid window ID and the corresponding pixel pair is readout, whereas a value of O means that it is not in any window and will not be readout. By loading up the RAM accordingly, the detector area can be thus divided up into a collection of windows of varying size. Note that windows must start on an even number in X and an odd number in Y.

For each pair of CCD rows, there is a location in the RAM that will contain a 'row action code'. This will specify what ϕ dowith the row pair as a whole. The values and meanings are

- 0 Perform vertical transfer only, i.e. no horizontal readout. This is used for skipping unvanted rows
- 2 Readout the row, ignoring window IDs, thus dumping unwanted charge build-up.
- 3 Readout Ite row, taking note of window I ds and transmitting the event data to the DPU.
- 8 Complete horizontal readout and skip to the start of frame transfer i.e. skip to end.

The table is loaded from the ICU via the ICB.

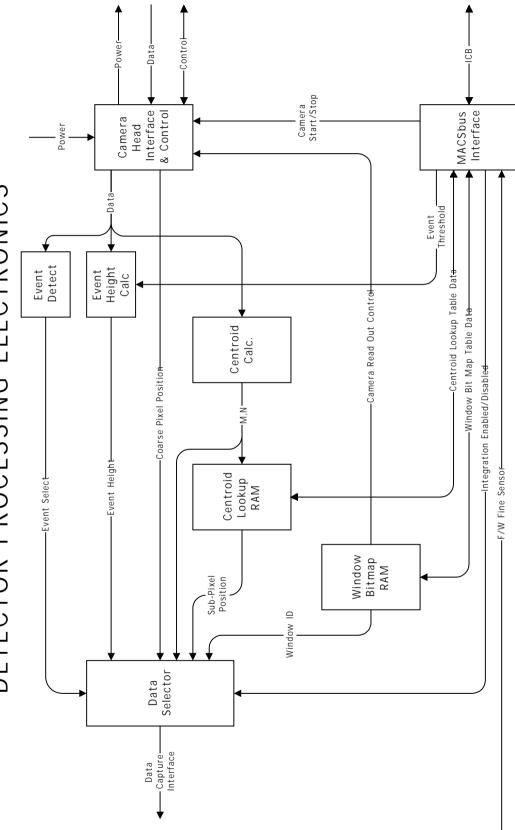
224.24.3 Centroid Lookup RAM

Centroiding is the processof locating the position of an event to an accuracy greater than that of a CCD pixel. For each event and in both the x and y axes, the processing electronics produces two 8 bt numbers, labelled m and n. The division m/n is the fractional position within a CCD pixel of the event. The range is divided into 8 bins, otherwise known as sub-pixels. Rather than performing this calculation, there are two (64k by 4 bit) tables containing all possible results of the division. The m and n are combined into a single 16 bt address which is used to lockup the result. The result is in the range 0-7.

Preparing the table contents requires two sets of 9' channel boundary' values giving the edges of the sub-pixels in both x and y. They are in the range -1.00to 1.00 These values are multiplied by 1000 for up-link purposes. The tables are loaded from the ICU via the ICB.







This copy printed at 11:33AM on 12-May-00

26

224.24.4 Output Data Formats

The output of the processing electronics to the DPU is a series of 24 bt words, one per event processed. The format of the word is determined by the data acquisition mode set via the ICB and is detailed in the figure overleaf. There are 4 scientific modes (numbered Oto 3) and effectively 2 engineering modes (numbered 4 to 7).

The scientific modes provide event positions in the form of the x and y CCD pixel number, the sub-pixel number in x and y and the window ID of the window in which they occurred. There are 2 full frame modes where the window ID is replaced by the most significant bits of the x and y CCD pixel counters, thus giving 16 tiles covering the full detector area

The engineering modes provide information for setting upand checking the detector. Modes 4 or 5 capture centroiding information in the form of events in which the x and y co-ordinates are replaced with the m and n values. The two 256yb256 pseudo images' thus formed can be used to calculate anewsub-pixel channel boundaries from which the centroid lockup table can be reloaded. Note that a) modes 4 and 5 are equivalent and both formats are transmitted at orceb) the first X M/N event for each frame is not transmitted. Modes 6 or 7 gives event height leading to a 1D image i.e. a histogram. They also produce event energy records in which the energy value is set to zero, due to this feature being removed from the design. Therefore, all records of this format should be ignored. Note that mode 6 and 7 are equivalent and both formats are transmitted at once

In addition, there are two words of all zeros, the 'frame tags', transmitted at the start of each frame. These are used for frame counting and timing purposes. This feature is enabled via the ICB. It should be disabled for engineering modes.

For the full frame modes only, windows should be defined so that the full detector area is covered, even though the window ID in bits 4 through 1 does not appear in the data. Instead, the high order bits of the CCD pixel coordinates are inserted. Because the DPU will regard these as a window ID, it is thus possible to have an apparent window ID of zero (which is impossible for the windowed modes).

For engineering modes, windows of any ID should be defined to cover the area of the detector from which information is required. The DPU will again regard bits 4 through 1 as a window ID.

A height threshold, set via the ICB, is used to select valid events. This value should be set bw (~8) for engineering data so as to obtain a full pulse height distribution. Otherwise avalue ~30 should be used.

When, as a result of a command, an integration is enabled, data is sent on to the DPU at the start of the next frame.

Detector Data Transmission Formats

Scienceor Detector 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0 Engineering Mode у 2 у 1 Х х YC 6-0 XC 6-0 2 1 ID Ρ Science 0 0 1 I Low Resolution, Windowed у 2 у 1 Х х Х Х 2 YC 5-0 0 XC 5-0 1 С СС С Ρ 0 0 Science 1 7 7 6 6 Low Resolution, Full Frame у 2 y O х Х Х y 0 YC 5-0 1 XC 5-0 3 2 Science 2 1 ID Ρ High Resolution, Windowed Y Y X X C C C C у 2 у 1 y O Х Х х 1 XC 5-0 3 2 Science 3 0 YC 5-0 Ρ 7 6 7 6 High Resolution, Full Frame 0 0 Engineering 0 0 0 1 Ρ 4 M value 0 N Value Engineering, X M/N Data 0 0 0 1 0 Ρ Engineering 5 0 M value 0 N Value Engineering, Y M/N Data Engineering 6 0 0 0 **EventHeight** 0 0 0 1 Ρ Engineering, Event Height Engineering 7 0 0 0 0 0 0 1 0 Ρ Engineering, Event Energy (contains no meaningful data)

P = Parity (Odd)

XC = X CCD Pixel Co-ordinate modulo 64 (high resolution) or modulo 128(low resolution)

YC = Y CCD Pixel Co-ordinate modulo 64 (high resolution) or modulo 128(low resolution)

x = X Sub-Pixel Bit

y = Y Sub-Pixel Bit

ID = WindowID

This copy printed at 11:33A M on 12-May-00

224.3 Mechanisms

2.2.4.3.1 Filter Wheel

Eleven optical elements are placed at equal angles around the filter whed. The whed is driven by a pinion on a 4phase stepper motor shaft, with a gear ratio of 11 to 1 Thus one revolution of the motor, which requires 200steps, moves the whed from one optical element to another and 2200steps will completely rotate the filter whed. The following table is based on Order of the Optical Elements on the Filter Whed, X MM-OM/MSSL/TC/0047.

Filter	Filter Whee	Description	Filter Position	Sensor	Value
Number	Station		(steps from datum)	Coarse	Fine
0	0	Blocked	1200	False	True
1	1	V	1400	False	True
2	2	Magnifier	1600	False	True
3	3	U	1800	False	True
4	4	В	2000	False	True
5	5	White	0	True	True
6	6	Grism 2 (Visible)	200	False	True
7	7	UVW1	400	False	True
8	8	UVM2	600	False	True
9	9	UVW2	800	False	True
10	10	Grism1(UV)	1000	False	True
11	3	Bar	2100	False	False

The wheel position will normally be determined in open loopmode by step counting from a known datum position. Coarse and fine position sensors are provided to relocate the datum position should it be lost, verify the wheel position during and after every rotation and to confirm that the catre of any optical element has been found although the dement is not identified. The reflective infra-red coarse position sensor is fitted to the wheel and gives a true output when the wheel is within about – 15° of the datum position. The infra-red fine position sensor, which is used in transmissive mode, is fitted to the rear end of the motor. An occulting dsk with a small aperture, through which the sensor locks, is fitted to the rear extension of the motor shaft. It is aligned such that an element will be correctly positioned when the fine sensor gives a true reading and the first phase is energised. Thus it is only at the datum position that both the coarse and fine sensors give a true output (see table above).

Tests indicated that the filter wheel should be rotated at a default pull-in speed of 200Hz, a cruise speed of 420Hz and an acceleration of 2000 Hz/sec. These rates are applied when moving from filter to filter or from datum to filter. However, in order to ensure success when seeking datum, the filter wheel is rotated at a constant 200Hz until the coarse sensor is detected and then at 10Hz until the fine sensor is seen.

The LED that Illuminates the coarse sensor is powered directly from the TMPSU. However, the fine sensor LED is powered and sensed via the detector electronics, which is dependent on the switched secondary power being enabled. This does not normally occur until the OM is in operational mode. Therefore, it is not possible to obtain full control of the filter wheel until that itme.

(See' Filter Wheel Mechanism Design', XMM-OM/MSSL/SP/0039 or more detail).

Note: The filter wheel movement is controlled via the ICB. This is also the main channel for acquiring housekeeping and controlling heaters. It was found duing testing that activity on the ICB during a filter wheel movement could introduce erratic motion of the filter wheel and cause occasional failure in locating the fine sensor. Therefore, whilst the filter wheel is being moved, all other ICB activity (such a housekeeping acquisition and leater control) is stopped. As a filter wheel movement takes between 5 - 10s, this will result in a loss of an HK telemetry packet on its expected 10 o 3 secboundary.

Similarly, activity on the SSI interface which channels DPU heartbeats and science data, can cause aproblem. Therefore the filter wheel is not moved until after the reception of the next DPU heartbeat. In addition, the normal science data 'handshake' between the DPU and ICU is suspended for the duration of the move.

2.2.4.3.2 Dichroic Mechanism

The dichroic mechanism contains a mirror placed at 4.9 in the path of the incoming beam. The purpose of the mechanism in the FM is to steer the reflected light beam from one of two redundant detector systems to the other. It will be rotated from one position to the other by pulse counting. The final step will drive the rotor to its stop where it will be held by a magnetic detent. The dichroic mechanism has to rotate 1.80° between the stops and is driven by a 4 step per revolution motor geared at 14.5.1. Therefore the motor needs to be driven up to 2.9 steps from one position to the other of the other is driven by a driven the stops required is 3.1. The step sequence has to be reversed to return. As there is no harm in overdriving the system against this stop, the motor is always driven the maximum number of steps required in the specified direction.

A pulse train must always finish on a particular phase. It is clear that this phase will be different at the two ends of the traverse. As there are no sensors in the system, the control mechanism is always open loop

The following algorithm is used. If we label the 4 phases 1,2,3 and 4 a dockwise rotor drive (viewed from the shaft end) towards the redundant detector is achieved by stepping in a positive direction (e.g. the phases are mergised in the order 1,2,3,4,1...) until the step count is equal to or greater than 3 land the phase is 1. Similarly a counter-clockwise rotor drive towards the primary detector is achieved by stepping in a negative direction (e.g. the phases are mergised in the order 4,3,2,1,4..) until the step count is equal to or greater than 3 land the phase is 1. Similarly a counter-clockwise rotor drive towards the primary detector is achieved by stepping in a negative direction (e.g. the phases are mergised in the order 4,3,2,1,4..) until the step count is equal to or greater than 3 land the phase is 2

224.4 Flood LED's

In order that the detector may be calibrated in flight, four floodLED's are provided. They are located off-axis close to the detector. They are positioned so that their focused emission falls on the side of the filter facing the detector. The filter used would be the blank which then acts as a defocused 'screen' providing the flat field. They are green LED's but with emission in the UV range.

Their intensity is controlled via ICB commands routed from the Blue Detector analogue control card to a 4 bit port. There are thus 16 posible levels. They are driven in such a way that if one should fail the remaining LED's will remain fully functional.

224.5 Heaters and Thermistors

There are 8 thermistors named and located as follows:

Name	Channel	Location
RefA	0	InterfaceFlange - Not connected - NCR 88
Ref B	1	InterfaceFlange
RefC	2	InterfaceFlange
Main	3	Near Main InterfaceHeater
Forward 1	4	Near Forward Heater
Forward 2	5	Near Forward Heater
CCD	6	CCD
BPE	7	BlueProcessingElectronics

(Note: the following is a summary of the document 'OM Heater Control', XMM-OM/MSSL/SP/0165

The four instrument heaters, and their function, are summarised as follows:	The four instrument heaters,	and their function,	are summarised as follows:
---	------------------------------	---------------------	----------------------------

Heater	Purpose
Main InterfaceHeater (HTR1)	This is located close to the interfaceflange on the telescope tube, and is intended to control the temperature at the interfacebolts to 19.5 – 0.5 °C using a dosed loopalgorithm. It has a control thermistor (Main) located close to it and there are 3 monitoring thermistors (Main, Ref B and Ref C) on the interfaceflange (Note: Ref A was not connected during assembly therefore Main is used as a monitoring point instead - NCR88).
Forward Heater (HTR2)	This is located at the forward of the telescope tube and is intended to control that area and hence the whole telescope tube to about the same temperature as the main interfaceheater - the default setting are 19.5 – 1.5 °C using a dosed loop algorithm. This should ensure that all of the telescope optical elements are sensibly isothermal. It is controlled by one of two thermistors (Forward 1 or Forward 2) mounted close to it.
Metering Rod Heaters (HTR3)	These are aset of threeparallel heaters, one mounted on each of the metering rods. These are used to extend the distance between the primary and secondary mirror by a small amount if necessary. This is done using an open loopalgorithm which defines an on-off ratio. It is disabled by default. NCR-192 The settings for this algorithm are, as of release 10 of the OM software, automatically set upon moving the filter wheel to a specified filter – see next section.
Secondary Mirror Mount Heater (HTR4)	This heater is used to shorten the separation of the primary and secondary mirror. NOTE that Iterefore this heater and the metering rod heaters will not be powered at Ite same time during rormal operation. This is done using an open loop algorithm which defines an on-off ratio. It is disabled by default NCR-192 The settings for this algorithm are, as of release 10 of the OM software, automatically set upon moving the filter wheel to a specified filter – seenext section.

224.6 Automatic Focus Heater Settings

During early operation, it was determined that the instrument point spread function was broader than expected due to a non-optimal focus – NCR-192 Investigation indicated that it was a function of which filter was used. As a result, and as from release 10 onwards of the OM software, a lock-up table of heater settings as a function of filter number was placed on-board. Whenever a filter wheel move is commanded that has been prefaced by the 'Set Filter Wheel Number' command (MFN=76@), the table is consulted and appropriate heater settings and sample times automatically set using the on-board equivalent routines of commands MFN=H7678 For release 10, this table starts at a base address of 23A4 (hex) in ICU data memory. Its format is as follows

Base Address	Description	
Offset		
(decimal)		
0	Position of Filter on Wheel	Parameters
1	On Time (in units of 'Sample Time')	for
2	Total Cycle Time (in units of 'Sample Time')	filter
3	Sample Time (in units of seconds)	0
4	Focus Direction (+ve = HTR3, -ve = HTR4 powered; 0 = unpowered)	(Blocked)
5	Parameters for Filter 1 (V)	
10	Parameters for Filter 2 (Magnifier)	
15	Parameters for Filter 3 (U)	
20	Parameters for Filter 4 (B)	
25	Parameters for Filter 5 (White)	
30	Parameters for Filter 6 (Grism 2- visible)	
35	Parameters for Filter 7 (UV W1)	
40	Parameters for Filter 8 (UV M2)	
45	Parameters for Filter 9 (UV W2)	
50	Parameters for Filter 10 (Grism 1 – UV)	
55	Parameters for Filter 11 (Bar)	

2.3 Software

2.3.1 Modes

The OM instrument has several overall modes. An outline of the function of these modes is given below. In addition, both the ICU and DPU have 2 different modes, 1) when they are running code present in the ROM (called 'basic' for the ICU or 'BootIdle' for the DPU) or 2) they are running uplinked code (called 'Operational' for the ICU and 'DPUOS' for the DPU. The characteristics, inter-relationship and required transitions between the modes, including the individual modes of the ICU and DPU, are given in more detail in the diagram and table overleaf.

23.1.1 Off

ICU and DPU are not powered. The Bootstrap Init mode is entered autonomously after power on

2.3.1.2 Bootstrap Init

The ICU is powered and

- 1. performs a reset of interfaces
- 2 copies required ROM to RAM.
- 3. initialises the software.
- 4. sets high vol tage ports to zero.
- 5. turns off the secondary power.
- 6. resets the DEMPSU.
- 7. moves the filter wheel close to the blank position (i.e. such that the coarse sensor is sen).

The software then autonomously enters the Bootstrap Reset mode.

2.3.1.3 Bootstrap Reset

The ICU is powered. The configuration is in a known state.

If entry to Bootstrap Init was from being powered on or as a result of a Cold Start Instruction to RBI, the ICU autonomously enters Basic Mode.

Otherwise, the transition to Basic Mode only occurs after receipt of the Start Instruction to RBI.

23.1.4 Initial/Basic

This is the first point at which telecommanding and telemetry are possible. It is possible to move to operational mode from here provided the ICU code has been uplinked since the last cycling of the Keep Alive Power. It is only possible to uplink ICU code in this mode.

2.3.1.5 Operational

At this point it is now possible to command and receive telemetry from the DPU. The secondary power is now enabled. There are four sub-modes Full Safe and Intermediate Safe, Idle, Science and Engineering and Calibration As of release 10 of the software (ECR 08) it is possible to request a transition to any one of these modes even if it is the current mode.

2.3.1.5.1 Safe

This has two sub-modes, Full and Intermediate.

2.3.1.5.1.1 Full Safe

A transition to this mode will cause the High V oltages to be in a safe condition. The filter wheel is moved to the blocked position. Should the latter operation fail for any reason, as from release 10 to the OM software it is not possible to leave this mode unless the filter wheel has been commanded to the blocked position (filter wheel absolute position 120)0

It is only possible to uplink the DPU code in this mode. This must be done before it is possible to move to Idle.

231.5.1.2 Intermediate Safe

A transition to this mode will cause the High V oltages to be in a condition whereby only the Cathode voltage is ramped down to zero. The filter wheel is moved to the blocked position.

2.3.1.5.2 Idle

In this mode it is possible to control the High Voltages and download previously acquired Science or Engineering Data. However, as from release 10 to the OM software, any at empt to ramp up any high voltage will fail unless the filter wheel is in the blocked position.

2.3.1.5.3 Science

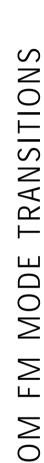
In this mode it is possible to acquire ascience image. It is also possible to control the High Voltages and download Science Data. However, as from release 10 of the OM software, any attempt to ramp upany high voltage will fail unless the filter wheel is in the blocked position.

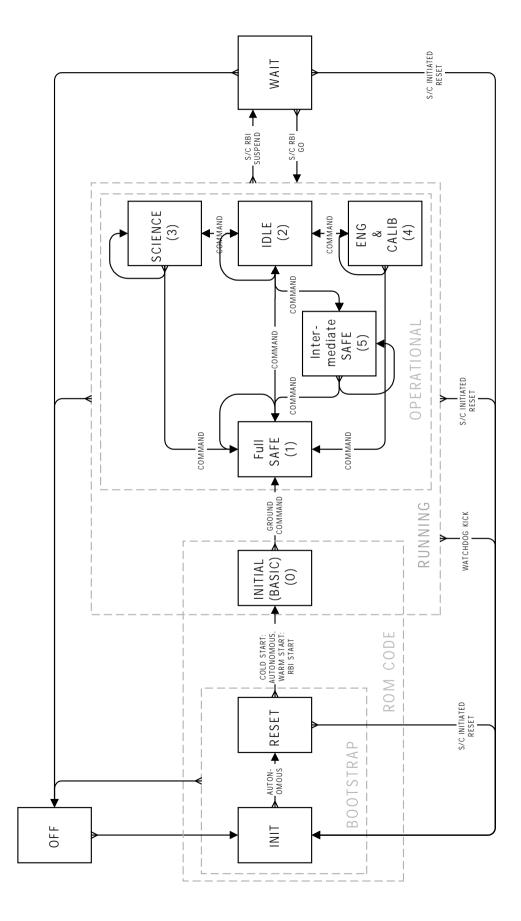
2.3.1.5.4 Engineering and Calibration

This is the only mode in which it is possible to move the Dichroic mechanism. Engineering images can be acquired. It is also possible to control the High Voltages and download Science Data. However, as from release 10 of the OM software, any attempt to ramp upany high voltage will fail unless the filter wheel is in the blocked position.

2.3.1.6 Wait State

The OM is powered but the ICU processor is in a halt state. It is possible to perform low-level memory dumps from and patches to the ICU. TM and TC Packets are not processed.





3.5

FM Model Mode Characteristics

				OFF	BOOTSTRAP	Ą			RUNNING			WAIT
					INIT	RESET	BASIC		OPERATIONA	I ONA L		
						_	. 1	Safe	Idle	Science	Eng.	
						_	0	Full Inter (1) (5)	(2)	(3)	(4)	
		Main	Main Power	Off	On	On	Ôn	On	Ôn	0	Ôn	On
	DEMPSU	Kea Pc	Keep Alive Power	On	NO	On	On	On	On	On	NO	On
OM2		≥	Mode	Off	Init	Reset	Basic	Operational	Operational	Operati onal	Operati onal	ICU CPU is halted
(DEM)	ICU	Teleα	Telecommand	Off	No	No	Yes	Yes	Yes	Yes	Yes	No
		Tde	Telemetry	Off	No	No	Yes	Yes	Yes	Yes	Yes	No
	DPU	2	Mode	Off	From OFF = Boot1dle dse unchanged	Bootldle	BootIdle	Boct Idle or DPUOS	DPUOS	DPUOS	DPUOS	Unchanged
		Comm	Commandable	JJО	No	No	No	Partial	Full	Full	Full	No
		Β Aαι	Data Aœuisition	Off	No	No	No	No	No	Commandable	Commandable	Unchanged
		⊳ P	Main Power	ЭЩ	чО	On	On	On	On	uO	On	On
		Seα Pc	Secondary Power	JJO	Off	Off	Off	On	On	uO	On	Unchanged
		De [.] High	Detector High V oltage	Оff	Off	Off	Off	Off V _{cathode} zero	On	On	On	U nchanged
	Electro- nics	Elec	Detector Electronics	Оff	Unchanged	Off	Off	On	On	uO	On	Unchanged
OM2		Τh	Thermal	Off	Unchanged	Off	HTR1 + HTR2 on	Closed Loap	Closed Loap	Closed Loap	Closed Loop	Powered Heaters stay on
(TM)		Floo	Flood LED	ЭШ	Unchanged	Off	Оff	Off	Off	Off	Commandable	Unchanged
			Position	Off	Unchanged	Blocked	Blocked	Blocked	Commandable	Commandable	Commandable	Unchanged
	Mechan- isms	Filter Wheel	Coarse Sensor	Off	Unchanged	Available	Available	Available	A vailable	Available	Available	Unchanged
		L	Fine Sensor	JJO	Unchanged	Unavailable	Unavailable	Available	A vailable	Available	Available	Unchanged
		Dichroic Comr	Dichroic mechanism Commandable	Off	No	No	No	No	No	No	Yes	No

36

2.3.2 ICU

2.3.2.1 Overview

The overall instrument function is provided by the instrument controller. Its main software functions are as follows -

- Configuring the instrument.
- Monitoring for breakdown/failure conditions (and safing if required).
- Controlling and monitoring status of, the detector, the telescope power supply and the DPU
- Incorporating new or modified code modules for itself or the DPU
- Collecting and telemetering instrument housekeeping and engineering packets
- A ccepting, reformat tng into packets and telemetering science data from the DPU
- Interfacing with the OBDH for data and commands.
- Monitoring and controlling the thermal environment.

The ICU software consists of 3 programs:-

BOOT STRAP
 This resides in ROM and is copied into RAM for execution. It is responsible for bringing up the ICU in a known safe state after turn on or spacecaft initiated reset, from either a cold or warm start. It also copies the basic state software from ROM to RAM.
 BASIC
 This resides in ROM and is copied into RAM for execution. Basic will be responsible for loading the uplinked ICU operational mode code into RAM, housekeeping and basic thermal control.
 OPERATIONAL
 This is uplinked and will reside in RAM. Operational provides the full functionality of the ICU. It also allows up-linking of the DPU DPUOS code to provide full OM

23.22 Bootstrap Code.

The bootstrap code is described in the Detailed Design Document, X MM-OM/MSSL/SP/0205

2323 Basic and Operational Code

2.3.2.3.1 Summary of Telecommands.

A full description of the telecommands is given in Telecommand and Telemetry Specification (X MM-OM/MSSL M/L /0010). In this manual, we will give a overview of the telecommands available to asist in the reading of that document, and indicate whether or not they are supported in tasic or operational mode.

2.3.2.3.2 Start Task Management Commands.

Sub-System	TID (Hex)	Task Function	MFN	Basic	Operat -tional
	10	Load Centroid Table	H5100		
	11	Load Window Table	H5110		
	12	Load DPU Deduced Window Table (always running)	۸A		
Detector	13	S tart (S top) Detector Integration	H5130	No	Yes
	14	High Voltage Ramp-up/down	H5140		
	18	Start Reset Camera Head Electronics (Contingency only)	H5180		
	4 4	Direct DPU Control (always running)	۸A		
Digital Processing Unit (DPU)	A5	(Start/Stop) Science Data Acquisition	H5250	No	Yes
	9 Y	(StartStop) DPU Heartbeat Watchdog	H5760		
Instrument Control Bus(ICB)	41	Enable ICB Load Port	H5410	Yes	Yes
RBI Watchog	50	Watchdog Enable	H5510	Yes	Yes
	09	Nove Filter Wheel	H5600	No	
Telescope Module Power Supply	95	Nove Dichroic mechanism	H5660	No	
(TMPS U)	99	Heater Control (Contingency)	H5660	No	Yes
	19	Heater Control	H5 <i>6</i> 70	Yes	
	69	Tum on/off Switchable Secondary Voltages	H5690	Yes	
DEM Power Supply Unit (DEMPSU)	80	Reset of DEM-PSU Latchup Protection Circuits/DPU On	H5800	Yes	Yes
Housekeeping	DO	Enable Housekeeping	H5700	Yes	Yes

2.3.2.3. Stop Task Management Commands.

	TID	Task Function	MFN	Basic	Operat
	(Hex)				-ional
	10	Load Centroid Table	H6100		
	11	Load Window Table	H6110	No	Yes
Detector	13	(Start)/Stop Detector Integration	H6130		
	14	High Voltage Ramp-up/down	H6140		
Digital Processing Unit (DPU)	ЧS	(Start/Stop) Science Data Acquisition	H6250	No	Yes
	A6	(Start/Stop) DPU Heartbeat Watchdog	H6760		
Instrument Control Bus(ICB)	41	Disable ICB Load Port	H6410	Yes	Yes
RBI Watchdog	50	Watchdog Disable	H6510	Yes	Yes
	90	Wove Filter Wheel	0099H	No	
Telescope Mbdule	65	Wove Dichroic mechanism	H6650	No	
Power Supply	99	Heater Control (Contingency)	H6660	No	Yes
(TMPSU)	67	Heater Control	0 <i>L</i> 99H	Yes	
	69	Turn on/off Switchable secondary voltages	0699H	Yes	
DEM Power Supply Unit (DEMPSU)	80	DPU Off	H6800	Yes	Yes
Housekeeping	DO	Disable Housekeeping	007.0H	Yes	Yes

2.3.2.3.4 Load Task Management Commands.

Sub System	TID (Hex)	Associated Start Task	FID (Hex)	Load Task Description	MFN	Basic	Operat- ional
	10	Load Centroid Table	00	Load Centroid Table Boundaries	H7100		
	11	Load WindowTable	00	Load Window Table	H7110		
	12	Load DPU Deduced WindowTable	00	E nable/Disable V erification	H7120		
			00	Set Acquisition Mode	H7130	No	Yes
Detector			01	Set Single Event Threshold	H7131		
	13	Detector Integration	04	Set Flood LED Current	H7134		
		2	05	Enable Frame Tag	H7135		
			90	Camera Running/Halted	H7136		
	14	High Voltage Ramp	00	Load HV Ramp Parameters	H7140		
DPU	4 4	Direct DPU Control	00Þ FF	DPU Commanding	see later	No	Yes
RBI	50	Watchdog Control	00	Reset Watchdog Parameters	H7310	Yes	Yes
			00	Set Coarse Position Sensor LED Current	H7600		
			01	Set Fine Position Sensor LED Current	H7601		
			02	Set Step Rate of Filter Wheel	H7602		
			03	ResetFilter Wheel Position Counter	H7603		
0			04	Set Filter Number	H7604		
	90	Move Filter Wheel	05	Set Absolute Step Position	H7605	No	Yes
TMPSU			90	Set Relative Step Position	H7606		
			07	Set Number of Fine Sensor Pulses	H7 607		
			08	Set next move to Datum	H7608		
			60	Set next move to Coarse Sensor	609 L H		
	92	Nove Dichroic mechanism	00	Set Direction of Dichroic Movement	H7650		
			01	Set Step Rate of Dichroic	H7 661		
	99	Heater Control (Contingency)	00	Heater Configuration	H7660		
	67	Heater Control	01Þ 08	Control Parameters	H7671 Þ H7678		
ICB	41	ICB Load	00	Load ICB Directly	H7410 P H7426	Yes	Yes

2.3.2.3.5 Report Task Commands. Read ICB AddressDirectly

onal						
Operational	Yes			Yes		
Basic	Yes		No Unless	Secondaries	Enabled	
Description	H7440 TMPSU Currents and F/W Coarse Sensor	Digital E lectronics S tatus Word	Digital Bitmap Datum	H7454 Digital Centroid Table Datum	ADC Housekeeping, HV Status, Fine Sensor	H7456 Initiate ADC
MFN	H7440	H7452	H7453	H7454	H7455	H7456
FID	0	2	З	4	5	9
Sub- system	TMPSU			Detector		
TID (hex)	47			58		

2.3.2.3.6 Mode Change Commands.

	Comment	MFN	Basic Oper.	Oper.
Ч	Initial	-	No	No
Sé	Safe (Full)	H9001Y es	Υes	Yes
pl	Idle	H9002No	No	Yes
S	Science mode	0NE006H	No	Yes
Er	Engineering and Calibration	H9004No	No	Yes
ŝ	Safe (Intermediate)	H9005No	No	Yes

2.3.2.3.7 Memory Management

2.3.2.3.7.1 Load Memory

MID	ICU & D	ICU & Detector Memory Description	Description	MFN	Basic Oper	Oper
(Hex)	Addresses	Sub-System Description	Description			
	0 - FFFF (hex)	ICU	Operand/D ata Space	H4000 Yes	Yes	No
0	10000-1FFFF (hex)	Detector	Window Bitmap Table	N∕A	No	Yes
	20000-2FFFF (hex)	Electronics	Centroid Look-up Table N/A	N∕A	No	Yes
1	0 - FFFF (hex)	ICU	Instruction Space	H4001 Yes	Yes	No

MID	MID DPU Local Memory Description	MFN	Basic Oper	Oper
(hex)				
10	10 DPU Blue 1 DSP Local Memory H4010	H4010		
11	DPU Blue 2DSP Local Memory H4011 N/A	H4011	N/A	Ν/A
12	12 DPU Red DSP Local Memory	H4012		
13	13 DPU White DSP Local Memory H4013 No	H4013		Yes

	MID DPU Global Memory Description	START	END	MFN	BASIC	OPER
(hex)		ADDRESS	ADDRESS			
14	DPU Big Word Memory (24 bt words)	000000	OFFFFF	H4014		
15	DPU Small Word Memory (16 bt words)	400000	7 F F F F F	H4015		
20	DPU Program Ram Bank O	E00000	EOFFFF	H4020		
21	DPU Program Ram Bank 1	E10000	Elffe	H4021		
22	DPU Program Ram Bank 2	E20000	EZFFFF	H4022	NO	YES
23	DPU Program Ram Bank 3	E30000	E3FFFF	H4023		
24	DPU Program Ram Bank 4	E40000	E4FFFF	H4024		
25	DPU Program Ram Bank 5	E50000	ESFFFF	H4025		
26	DPU Program Ram Bank 6	E60000	EGFFFF	H4026		
27	DPU Program Ram Bank 7	E70000	E7FFF	H4027		
Í						

2.3.2.3.7.2 Dump Memory

Oper			Yes			
Basic		Yes	No	No	Yes	
MFN		H4100	H4100	H4100	H4101	
Description	Description	Operand/Data Space	Window Bitmap Table	Centroid Look-up Table	Instruction Space	
ICU & Detector Memory Description	Sub-System Description	ICU	Detector	Electronics	ICU	
ICU & De	Addresses	0 - FFFF (hex)	10000 - 1FFFF (hex)	20000 - 2FFFF (hex)	0 - FFFF (hex)	
MID	(Hex)		0		1	

(hav)	DPU Local Memory Description	MFN	Basic	Oper
10	DPU Blue 1 DSP Local Memory	H4110		
11	DPU Blue 2 DSP Local Memory	H4111	N/A	N/A
12	DPU Red DSP Local Memory	H4112		
13	DPU White DSP Local Memory	H4113	No	Yes

MID	MID DPU Global Memory Description	START	END	MFN	BASIC	OPER
(hex)		ADDRESS	ADDRESS			
14	DPU Big Word Memory (24 bit words)	000000	OFFFF	H4114		
15	DPU Small Word Memory (16 bit words)	400000	7FFFF	H4115		
20	DPU Program Ram Bank 0	E00000	EOFFFF	H4120		
21	DPU Program Ram Bank 1	E10000	Elfff	H4121		
22	DPU Program Ram Bank 2	E20000	EZFFFF	H4122	NO	OPER
23	DPU Program Ram Bank 3	E30000	ЕЗЕГЕГ	H4123		
24	DPU Program Ram Bank 4	E40000	E4FFF	H4124		
25	DPU Program Ram Bank 5	E50000	ESFFFF	H4125		
26	DPU Program Ram Bank 6	E60000	EGFFFF	H4126		
27	DPU Program Ram Bank 7	E70000	E7FFF	H4127		

2.3.2.3.7.3 Calculate Memory Checksum

MID	ICU & De	ICU & Detector Memory Description	Description	MFN	MFN Basic	Oper
Hex)	Addresses	Sub-System Description	Description			
	0 - FFFF (hex)	ICU	Operand/Data Space	H4200 Yes	Yes	
_	10000 - 1FFFF (hex)	Detector	Window Bitmap Table	N/A	No	Yes
	20000 - 2FFFF (hex)	Electronics	Centroid Look-up Table	N/A	N_{O}	
	0 - FFFF (hex)	ICU	Instruction Space	H4201	Yes	

MID	MID DPU Local Memory Description	MFN	MFN Basic Oper	Oper
(hex)				
10	DPU Blue 1 DSP Local Memory			
11	DPU Blue 2 DSP Local Memory	N/A	N/A	N/A
12	DPU Red DSP Local Memory			
13	DPU White DSP Local Memory			

ADDRESS OFFEFE 7FFFFF EOFFFF E1FFFF E1FFFF E3FFFF E3FFFF E5FFFF E5FFFF E6FFFF E6FFFF	MID	MID DPU Global Memory Description	START	END	MFN	BASIC	OPER
DPU Big Word Memory (24 bit words)000000 $0FFFF$ DPU Small Word Memory (16 bit words)400000 $7FFFF$ DPU Program Ram Bank 0 $E00000$ $E0FFF$ DPU Program Ram Bank 1 $E10000$ $E1FFF$ DPU Program Ram Bank 2 $E20000$ $E1FFF$ DPU Program Ram Bank 3 $E10000$ $E1FFF$ DPU Program Ram Bank 3 $E30000$ $E2FFFF$ DPU Program Ram Bank 3 $E30000$ $E3FFFF$ DPU Program Ram Bank 4 $E40000$ $E3FFFF$ DPU Program Ram Bank 5 $E40000$ $E3FFFF$ DPU Program Ram Bank 5 $E40000$ $E3FFFF$ DPU Program Ram Bank 5 $E70000$ $E3FFFF$	(hex)		ADDRESS	ADDRESS			
DPU Small Word Memory (16 bit words) 400000 $7EFEF$ DPU Program Ram Bank () $E00000$ $E0FEFE$ DPU Program Ram Bank 1 $E10000$ $E1FFF$ DPU Program Ram Bank 2 $E20000$ $E1FFF$ DPU Program Ram Bank 2 $E20000$ $E2FFFE$ DPU Program Ram Bank 3 $E30000$ $E3FFFE$ DPU Program Ram Bank 4 $E40000$ $E3FFFE$ DPU Program Ram Bank 5 $E40000$ $E3FFFE$ DPU Program Ram Bank 5 $E40000$ $E4FFFE$ DPU Program Ram Bank 5 $E50000$ $E5FFF$ DPU Program Ram Bank 6 $E50000$ $E6FFF$	14	DPU Big Word Memory (24 bit words)	000000	OFFFFF			
DPU Program Ram Bank 0 E00000 E0FFF DPU Program Ram Bank 1 E10000 E1FFF DPU Program Ram Bank 2 E20000 E3FFF DPU Program Ram Bank 3 E30000 E3FFF DPU Program Ram Bank 3 E30000 E3FFF DPU Program Ram Bank 4 E40000 E3FFFF DPU Program Ram Bank 4 E40000 E4FFFF DPU Program Ram Bank 5 E50000 E5FFFF DPU Program Ram Bank 6 E50000 E5FFFF	15	DPU Small Word Memory (16 bit words)	400000	JEFEF			
DPU Program Ram Bank 1 E10000 E1FFF N/A DPU Program Ram Bank 2 E20000 E2FFF N/A N/A DPU Program Ram Bank 3 E30000 E3FFF N/A N/A DPU Program Ram Bank 3 E30000 E3FFF N/A N/A DPU Program Ram Bank 4 E40000 E4FFF P P DPU Program Ram Bank 5 E50000 E5FFF P P DPU Program Ram Bank 6 E60000 E5FFF P P DPU Program Ram Bank 6 E60000 E5FFF P P	20	DPU Program Ram Bank 0	E00000	EOFFFF			
DPU Program Ram Bank 2 E20000 E2FFF N/A N/A DPU Program Ram Bank 3 E30000 E3FFFF N/A N/A DPU Program Ram Bank 4 E40000 E4FFFF E40000 E4FFFF DPU Program Ram Bank 5 E50000 E5FFF E60000 E6FFFF DPU Program Ram Bank 6 E60000 E6FFFF E70000 E6FFFF	21	DPU Program Ram Bank 1	E10000	Elfff			
DPU Program Ram Bank 3 E30000 DPU Program Ram Bank 4 E40000 DPU Program Ram Bank 5 E50000 DPU Program Ram Bank 6 E60000 DPU Program Ram Bank 7 E70000	22	DPU Program Ram Bank 2	E20000	EZFFFF	N/A	N/A	N/A
DPU Program Ram Bank 4 E40000 DPU Program Ram Bank 5 E50000 DPU Program Ram Bank 6 E60000 DPU Program Ram Bank 7 E70000	23	DPU Program Ram Bank 3	E30000	ЕЗЕГЕ			
DPU Program Ram Bank 5 E50000 DPU Program Ram Bank 6 E60000 DPU Program Ram Bank 7 E70000	24	DPU Program Ram Bank 4	E40000	E4FFF			
DPU Program Ram Bank 6 E60000 DPU Program Ram Bank 7 E70000	25	DPU Program Ram Bank 5	E50000	ESFFFF			
DPU Program Ram Bank 7 E70000	26	DPU Program Ram Bank 6	E60000	Ебеге			
		DPU Program Ram Bank 7	E70000	E7FFF			

45

2.3.2.3.8 Telemetry Maintenance

Function	Basic	Oper
Report TM Packet Generation Status		
Disable Generation of All Packets	Yes	Yes
Enable Generation of Specific Packets		
Disable Generation of Specific Packets		

2.3.2.3.9 Time Management.

Function	Basic	Oper
Enable Time Synchronisation		
Add Time Code	Yes	Yes
Enable Time Verification		

2.3.2.3.10 Test Commands

F unction	MFN	Basic	Oper
Test Command	H1	Yes	Yes

This copy printed at 11:33 AM on 12-May-00

2.3.2.3.11 Summary of Telemetry

A full description of the telemetry is given in Telecommand and Telemetry Specification (X MM-OM/MSSL/ML/CO10). In this manual, we will give asummary of the telemetry available to assist in the reading of that document.

Туре	Telemetry	Packets A vailable	Comments
Housekeeping	НК	at 10 secs	Selected by SID value
1 0		at 3 secs	
Telecommand	Successful (Command Acceptance	
Verification		I Command Acceptance	
		Il Command Execution	
		from Detector System	
	Event	from Mechanisms	
	Reports	of Selected DPU Alerts	Selected by SID
		Bootstrap Report	Ĭ
Non Periodic		from Detector System	
Housekeeping		of ICB errors	Only when enabled
		if ADA exception	Ť
	Exception	lossof mechanism position	
	Reports	of SSI errors	Always enabled
	Bootstrap Report		If booting encounters problems
		of all DPU error Alerts	
Task Management	ICB Port re	ad-back	
	Memory	ofICU	
Memory	Dump	of DPU	
Maintenance	Reports	of Detector Tables	
		necksum Reports for ICU	
Telemetry Management	TM Packet	Generation Status Report	
Time Management	TimeVerifi	cation Report	
		WindowData	
	Priority	Field Acquisition Data	
		Fast Mode Data	
Science		TrackingHistory	
		Reference Frame Data	
	Regular	Image Mode Data	
		Fast Mode Data	
		EngineeringData	
	Auxiliary D	ata	Only when enabled by SID

2.3.2.3.12 Main Software Components for Basic and Operational.

The diagrams overleaf illustrate the control and data flows between the main software components for both basic and operational code. A brief explanation of each component is also given. These two modes share many components. Their similarities and differences are summarised below, together with the type of telecommands (and Task Identifier - TID - if appropriate) they service This section is abstracted from APP-8, in which a full description of the ICU software can be found.

Component	Type of T C	TID (HEX)	Function in Basic	Function in Operational
DEMPSU	5	80	Resets DEMPSU Latchup Turns-on DPU if Off	Resets DEMPSU Latchup Turns-on DPU if Off Turns off DPU
DETECTOR	5	10 Þ 18	ABSENT	Control and monitor detector.
DPU MANA GER	5	A4 ₽A6	 Monitors DPU heartbeats and sends the count of the HK 	 Uses SSI to communicate with the DPU. Configure and control DPU modes. Control Science and Engineering data flow from DPU and send to TM QUEUE. Monitors DPU heartbeats
НК	5	DO	 Collect and passHK packets to the TM QUEUE that monitor only the TMPSU and DPU heartbeats. 	 Collect and passHK packets to the TM QUEUE for the whole OM.
ICB	5	41	Controls dataflow to/from the instrument subsystems using the ICB interface	Controls dataflow to/from the instrument subsystems using the ICB interface.
MECHANISMS	5	60 65	ABSENT	 Control & monitor mechanisms (filter wheels, dichroic mechanism).
MEMORY MANA GER	6	-	Supports memory uplink and downlink and memory checksum calculations for the ICU only	 Supports memory uplink and downlink for the DPU only.
MODE MANA GER	5	-	 Implements mode change request of Safe 	Implements mode change requests from spacecraft
RBI	5,1 O	50	 Provides routines to support the RBI chip Handle appropriate interrupts to the TC and TM queues and time. Supply Watchdog Fadlity 	 Provides routines to support the RBI chip Handle appropriate interrupts to the TC and TM queues and time. Supply Watchdog Fadility
SAFING	5	D1	ABSENT	 Implements command to SAFE mode Implements Autonomous Safing
SSI	see DPU	-	Obtains info from the DPU using the SSI interface	 Passes control and data info to the DPU using the SSI interface Obtains info from the DPU using the SSI interface

Continued on rext page...

X MM-OM User Manual (FM)

Component	Type of T C	TID (HEX)	Function in Basic Function in Operational
TASK MANA GER	5		Implements the task management packet requests implements the task management packet requests
TC PROCESS	AII		 Obtains telecommand packets from the telecommand queue. Verifies, acknowledges and routes telecommand packets - the 'main' program Obtains telecommand packets from the telecommand queue. Verifies, acknowledges and routes telecommand packets - the 'main'
THERMAL	5	666 7	 Enables or disables Provide full thermal control Main and Forward Heaters simultaneously.
TIME MANA GER	10	-	 Implements the Time management packet requests (verification and synchronisation). Provide time stamps for packets Implements the Time management packet requests (verification and synchronisation). Provide time stamps for packets.
TE MEMETRY MANA GER	9	_	 Enables/Disables packets defined by their SID'S Enables/Disables packets defined by their SID'S
TMQUEUE	Supplies TM	_	 Provide ability to control and queue telemetry packets for downlink. Provide ability to control and queue telemetry packets for downlink.

This copy printed at 11:33A M on 12-May-00

I

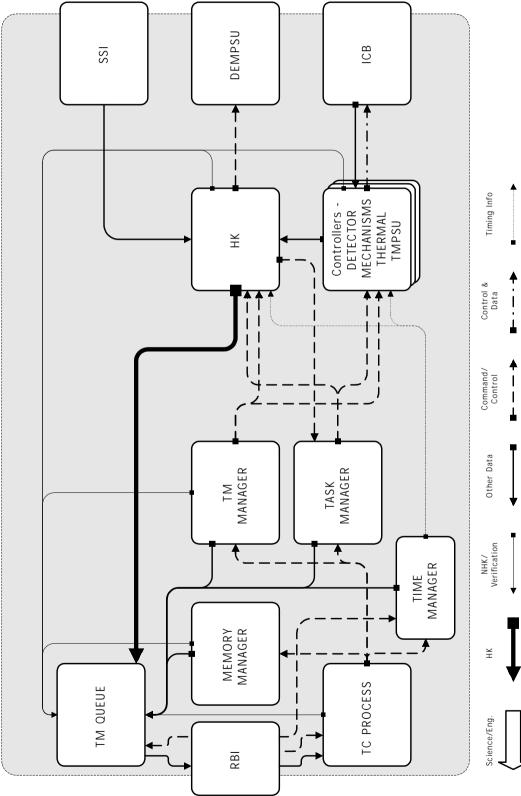
2.3.2.3.13 Overview of Principle Memory Areas SeeA PP-8 for more detail.

CodeAdd	ress(hex)	Description
Start	End	
0	3FF	Bootstrap
400	3FFF	Basic Mode
3800	FFFF	Operational Mode

Data Add	ress(hex)	Description
Start	End	
2C7	2D4	Bootstrap Deduced ICU Status
2F1	313	Bootstrap Filter Wheel Acceleration Table
3F2	3FD	Memory Loading Work A rea
400	403	RBI Communications Area (CCA)
404	5F3	TC Queue
5F4	9FF	TMQueue
A00	AOA	RBI Code Work A rea
AOB	AOB	SSI Code Work A rea
FC0	FCF	DEBUG Area
1000	1B55	Basic Mode Operands
1C00	4A10	Operational Mode Operands
23A4	23DB	Focus Heater Settings as function of Filter Wheel
E900	FD00	Main Program Stack
FD01	FFFF	Interrupt Stack

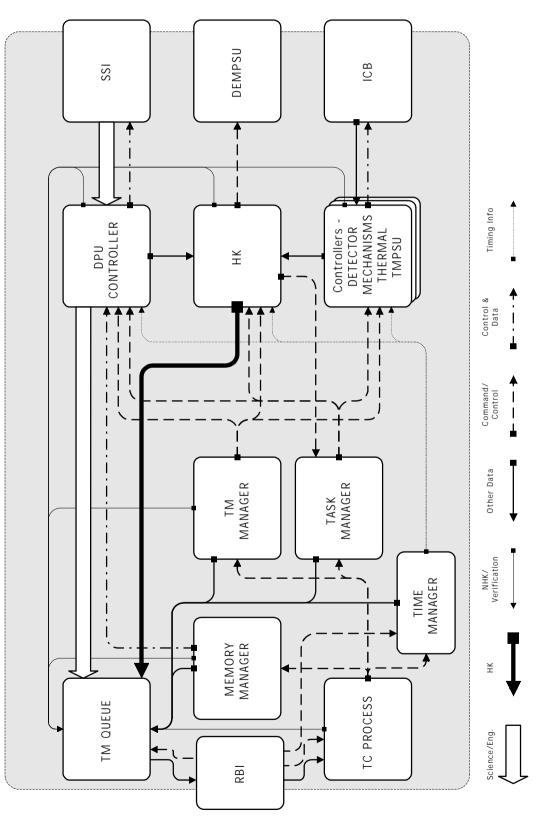
This copy printed at 11:33A M on 12-May-00





50





2.3.3.1 Overview

APP-9 should be consulted for full details on the DPU operation. This document will confine itself to an overview.

The detector is a photon-counting system. Estimates of the count rate from the field (2e5/sec) imply that for a 1024 x 1024 format image, the bit rate would be 4 Mbit/second This grossly exceeds the available data rate for X MM as a whole.

To compress this bit rate, the DPU software stores the images in an accumulating memory, for a time compatible with scientific objectives (typically 1000seconds). However, the spacecraft attitude may drift by more than one imaging pixel on these time scales and produce image blurring. It is the primary goal of the DPU software to compensate for this

A secondary requirement is to provide high time resolution data of a reduced set of scientific data. For example, some X -ray targets will have interesting intensity variations with time-scale much shorter than an image collection interval. The data is extracted for limited portions of the image on time scales from milliseconds to seconds. It must also provide engineering and housekeeping. In addition, the data is also compressed.

All data types are sent of the ICU for reformatting into packets.

The diagrams overleaf illustrate the main software components in each processor, their functionality in each DPU mode (Boot and DPUOS) and their inter-relationships.

2.3.3.2 Global RAM Map

The global ram is divided as follows -

start (hex)	end (hex)	description	comment
0	7fff	PROC	
8000	fffff	big word memory	spilt in half for current and previous exposure
100000	3fffff	unused	
400000	5fffff		ping-pong area for data aquisition and tracking
600000	6fffff	small word memory	fast mode data store
700000	7ffff		compressed data store
800000	dfffff	unused	
e00000	~e10000		white swap unit codes
e30000	~e31000	RAM program	blue codes
e50000	~e53000	code area	red codes
e70000	~e73000		white dpuos codes
e7ff00	e7ffff		loader lockup table
£00000	ffffff	ROM code area	Addresses at the very high end are reserved by Motorola

XMM-OM User Manual (FM)

XMM-OM/MSSL/ML/0008.5

